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October 1995 Revised May 2003

NC7S32

TinyLogic® HS 2-Input OR Gate

General Description

The NC7S32 is a single 2-Input high performance CMOS OR Gate. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad V_{CC} range. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. Three stages of gain between inputs and outputs assures high noise immunity and reduced sensitivity to input edge rate.

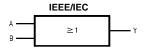
Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed; t_{PD} 3.5 ns typ
- \blacksquare Low Quiescent Power; $I_{CC} < 1~\mu\text{A}$
- Balanced Output Drive; 2 mA I_{OL}, -2 mA I_{OH}
- Broad V_{CC} Operating Range: 2V–6V
- Balanced Propagation Delays
- Specified for 3V Operation

Ordering Code:

| Order Number | Package Number | Product Code Top Mark | Package Description | Supplied As | |
|--------------|-------------------|--------------------------|---------------------------------------|---------------------------|--|
| NC7S32M5X | MA05B | 7S32 | 5-Lead SOT23, JEDEC MO-178, 1.6mm | 3k Units on Tape and Reel | |
| NC7S32P5X | MAA05A | S32 | 5-Lead SC70, EIAJ SC-88a, 1.25mm Wide | 3k Units on Tape and Reel | |
| NC7S32L6X | MAC06A | TT | 6-Lead MicroPak, 1.0mm Wide | 5k Units on Tape and Reel | |

Logic Symbol



Pin Descriptions

| Pin Names | Description |
|-----------|-------------|
| A, B | Inputs |
| Y | Output |
| NC | No Connect |

Function Table

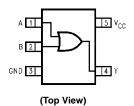
$$Y = A + B$$

| Inp | Output | | | |
|-----|--------|---|--|--|
| Α | A B | | | |
| L | L | L | | |
| L | Н | Н | | |
| Н | L | Н | | |
| Н | Н | Н | | |

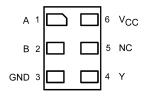
H = HIGH Logic Level L = LOW Logic Level

Connection Diagrams

Pin Assignments for SC70 and SOT23



Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{\tiny TM}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Absolute Maximum Ratings(Note 1)

-0.5V to $V_{CC} + 0.5V$

260°C

Recommended Operating Conditions (Note 2)

| Supply Voltage (V _{CC}) | -0.5V to +7.0V |
|---|----------------------------|
| DC Input Diode Current (I _{IK}) | |
| $@V_{IN} \le -0.5V$ | –20 mA |
| $@V_{IN} \ge V_{CC} + 0.5V$ | +20 mA |
| DC Input Voltage (V _{IN}) | $-0.5V$ to $V_{CC} + 0.5V$ |
| DC Output Diode Current (IOK) | |

-20 mA $@V_{OUT}\!<\!-0.5V$ $@V_{OUT} > V_{CC} + 0.5V$ +20 mA

DC Output Voltage (V_{OUT}) DC Output Source or Sink

Current (I_{OUT}) ±12.5 mA

DC V_{CC} or Ground Current per Output Pin (I_{CC} or I_{GND}) ±25 mA

-65°C to +150°C Storage Temperature (T_{STG}) Junction Temperature (T_J) 150°C

Lead Temperature (T_L)

(Soldering, 10 seconds)

Power Dissipation (PD) @ +85°C

SOT23-5 200 mW SC70-5 150 mW Supply Voltage (V_{CC}) 2.0V to 6.0V Input Voltage (V_{IN}) 0V to V_{CC} Output Voltage (V_{OUT}) 0V to V_{CC} Operating Temperature (T_A) -40° C to $+85^{\circ}$ C

Input Rise and Fall Time $(t_r, \, t_f)$

V_{CC} @ 2.0V 0 to 1000 ns V_{CC} @ 3.0V 0 to 750 ns V_{CC} @ 4.5V 0 to 500 ns V_{CC} @ 6.0V 0 to 400 ns

Thermal Resistance (θ_{JA})

SOT23-5 300°C/W 425°C/W SC70-5

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

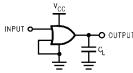
| Symbol | Parameter | v _{cc} | | T _A = +25°C | ; | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | | Units | Condition |
|-----------------|---------------------------|-----------------|--------------------|------------------------|--------------------------------|---|-------------------------------|-------|--|
| Cymbol | | (V) | Min | Тур | Max | Min | Max | Onno | Condition |
| V _{IH} | HIGH Level Input Voltage | 2.0 | 1.50 | | | 1.50 | | V | |
| | | 3.0-6.0 | 0.7V _{CC} | | | 0.7V _{CC} | | V | |
| V _{IL} | LOW Level Input Voltage | 2.0 | | | 0.50 | | 0.50 | V | |
| | | 3.0-6.0 | | | $0.3~\mathrm{V}_{\mathrm{CC}}$ | | $0.3\mathrm{V}_{\mathrm{CC}}$ | V | |
| V _{OH} | HIGH Level Output Voltage | 2.0 | 1.90 | 2.0 | | 1.90 | | | |
| | | 3.0 | 2.90 | 3.0 | | 2.90 | | V | $I_{OH} = -20 \mu A$ $V_{IN} = V_{IH}$ |
| | | 4.5 | 4.40 | 4.5 | | 4.40 | | V | $V_{IN} = V_{IH}$ |
| | | 6.0 | 5.90 | 6.0 | | 5.90 | | | |
| | | | | | | | | | $V_{IN} = V_{IH}$ |
| | | 3.0 | 2.68 | 2.85 | | 2.63 | | V | $I_{OH} = -1.3 \text{ mA}$ |
| | | 4.5 | 4.18 | 4.35 | | 4.13 | | V | $I_{OH} = -2 \text{ mA}$ |
| | | 6.0 | 5.68 | 5.85 | | 5.63 | | | $I_{OH} = -2.6 \text{ mA}$ |
| V_{OL} | LOW Level Output Voltage | 2.0 | | 0.0 | 0.10 | | 0.10 | | |
| | | 3.0 | | 0.0 | 0.10 | | 0.10 | V | $I_{OL} = 20 \mu A$ $V_{IN} = V_{IL}$ |
| | | 4.5 | | 0.0 | 0.10 | | 0.10 | V | $V_{IN} = V_{IL}$ |
| | | 6.0 | | 0.0 | 0.10 | | 0.10 | | |
| | | | | | | | | | $V_{IN} = V_{IL}$ |
| | | 3.0 | | 0.1 | 0.26 | | 0.33 | V | $I_{OL} = 1.3 \text{ mA}$ |
| | | 4.5 | | 0.1 | 0.26 | | 0.33 | V | $I_{OL} = 2 \text{ mA}$ |
| | | 6.0 | | 0.1 | 0.26 | | 0.33 | | $I_{OL} = 2.6 \text{ mA}$ |
| I _{IN} | Input Leakage Current | 6.0 | | | ±0.1 | | ±1.0 | μΑ | $V_{IN} = V_{CC}$, GND |
| I _{CC} | Quiescent Supply Current | 6.0 | | | 1.0 | | 10.0 | μΑ | $V_{IN} = V_{CC}$, GND |

AC Electrical Characteristics

| Symbol | Parameter | v _{cc} | | $T_A = +25^{\circ}C$ | | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | | Units | Conditions | Figure |
|--------------------|-------------------------------|-----------------|-----|----------------------|-----|---|-----|-------|-------------------------|-----------------|
| | | (V) | Min | Тур | Max | Min | Max | Units | Conditions | Numbe |
| t _{PLH} , | Propagation Delay | 5.0 | | 3.5 | 15 | | | ns | $C_{L} = 15 \text{ pF}$ | |
| t_{PHL} | PHL | | | 20 | 100 | | 125 | | | 1_ |
| | | 3.0 | | 12 | 27 | | 35 | ns | C _L = 50 pF | Figures 1, 3 |
| | | 4.5 | | 8 | 20 | | 25 | | | |
| | | 6.0 | | 7 | 17 | | 21 | | | |
| t _{TLH} , | Output Transition Time | 5.0 | | 3.0 | 10 | | | ns | $C_{L} = 15 \text{ pF}$ | |
| t_{THL} | | 2.0 | | 25 | 125 | | 155 | | | |
| | | 3.0 | | 16 | 35 | | 45 | 20 | C = 50 pE | Figures 1, 3 |
| | | 4.5 | | 11 | 25 | | 31 | ns | $C_L = 50 pF$ | 1,0 |
| | | 6.0 | | 9 | 21 | | 26 | | | |
| C _{IN} | Input Capacitance | Open | | 2 | 10 | | 10 | pF | | |
| C _{PD} | Power Dissipation Capacitance | 5.0 | | 6 | | | | pF | (Note 3) | Figure 2 |

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See *Figure 2*) C_{PD} is related to I_{CCD} dynamic operating current by the expression:
I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).

AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz, t_w = 500 ns

FIGURE 1. AC Test Circuit



Input = AC Waveforms;

PRR = variable; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

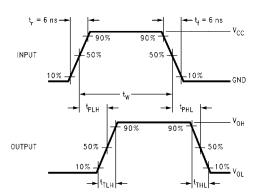


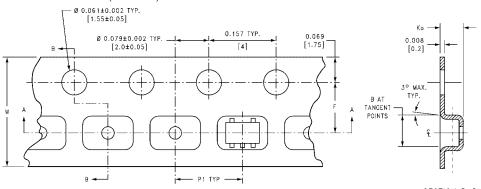
FIGURE 3. AC Waveforms

Tape and Reel Specification

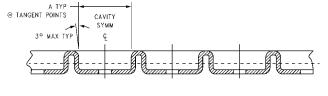
TAPE FORMAT for SC70 and SOT23

| TAI E I GRAMAT TOT GOTT GITG GGT 25 | | | | | | | | |
|-------------------------------------|--------------------|-----------|--------|------------|--|--|--|--|
| Package | Таре | Number | Cavity | Cover Tape | | | | |
| Designator | Section | Cavities | Status | Status | | | | |
| | Leader (Start End) | 125 (typ) | Empty | Sealed | | | | |
| M5X, P5X | Carrier | 3000 | Filled | Sealed | | | | |
| | Trailer (Hub End) | 75 (typ) | Empty | Sealed | | | | |

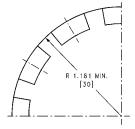
TAPE DIMENSIONS inches (millimeters)



DIRECTION OF FEED _____



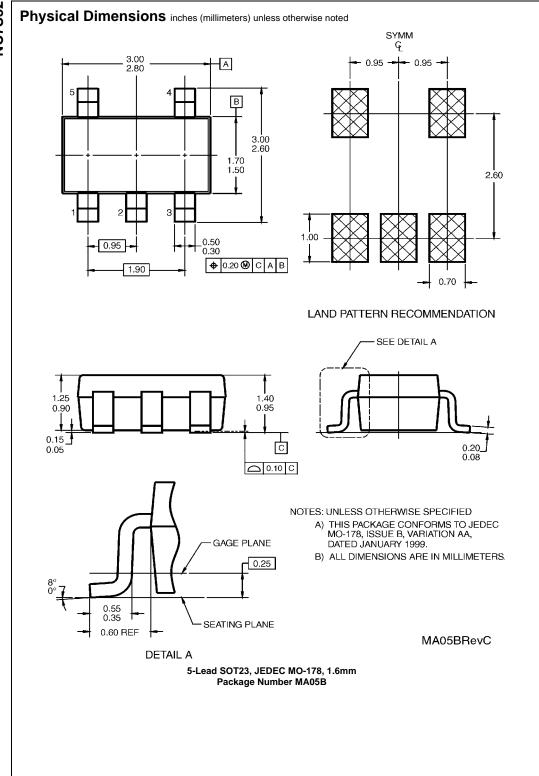
SECTION A-A

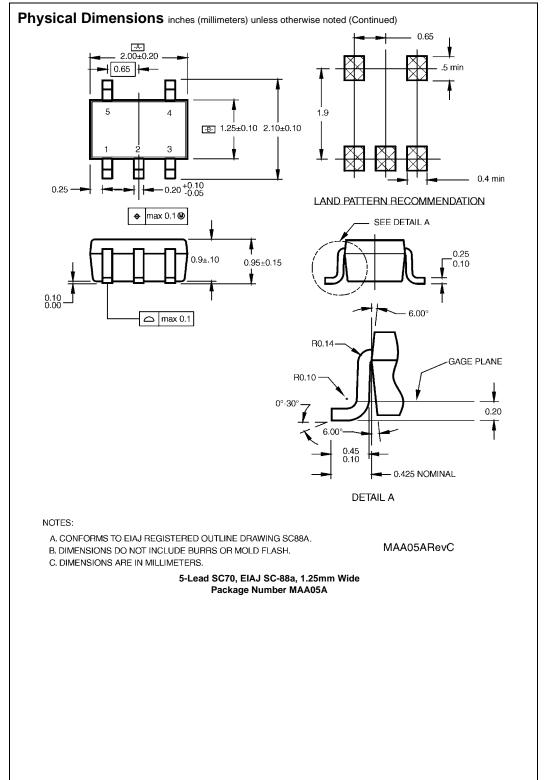


BEND RADIUS NOT TO SCALE

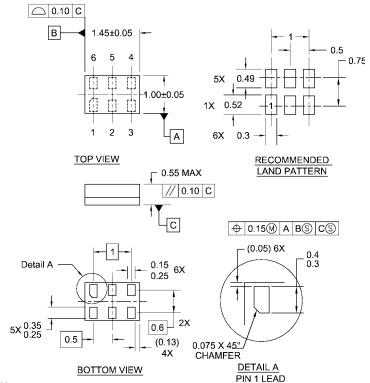
| Package | Tape Size | DIM A | DIM B | DIM F | DIM K _o | DIM P1 | DIM W |
|---------|-----------|--------|--------|--------------|--------------------|--------|--------------|
| SC70-5 | 8 mm | 0.093 | 0.096 | 0.138 ±0.004 | 0.053 ±0.004 | 0.157 | 0.315 ±0.004 |
| | | (2.35) | (2.45) | (3.5 ±0.10) | (1.35 ±0.10) | (4) | (8 ±0.1) |
| SOT23-5 | 8 mm | 0.130 | 0.130 | 0.138 ±0.002 | 0.055 ±0.004 | 0.157 | 0.315 ±0.012 |
| | | (3.3) | (3.3) | (3.5 ±0.05) | (1.4 ±0.11) | (4) | (8 ±0.3) |

Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 2.00-1.75±0.10 В 8.00 ^{+0.30} -0.10 3.50±0.05 1.15±0.05 **-** → В◄ -ø 0.50 ±0.05 SECTION B-B DIRECTION OF FEED SCALE:10X 0.254±0.020 Γ ^{0.70±0.05} SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X DETAIL X SCALE: 3X W1 W2 Tape N W3 В С D Size 7.0 0.331 +0.059/-0.000 W1 +0.078/-0.039 0.059 0.512 0.795 2.165 0.567 8 mm (177.8)(1.50)(13.00)(20.20)(55.00)(8.40 +1.50/-0.00) (W1 +2.00/-1.00) (14.40)





Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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